


## Insulated Gate Bipolar Transistor (Ultrafast IGBT), 75 A


**SOT-227**

### FEATURES

- NPT Generation V IGBT technology
- Square RBSOA
- HEXFRED® low  $Q_{rr}$ , low switching energy
- Positive  $V_{CE(on)}$  temperature coefficient
- Fully isolated package
- Speed 8 kHz to 60 kHz
- Very low internal inductance ( $\leq 5$  nH typical)
- Industry standard outline
- UL approved file E78996 
- Compliant to RoHS directive 2002/95/EC


**RoHS**  
COMPLIANT

### PRODUCT SUMMARY

$V_{CES}$	1200 V
$I_C$ DC	75 A at 95 °C
$V_{CE(on)}$ typical at 75 A, 25 °C	3.3 V

### BENEFITS

- Designed for increased operating efficiency in power conversion: UPS, SMPS, welding, induction heating
- Easy to assemble and parallel
- Direct mounting on heatsink
- Plug-in compatible with other SOT-227 packages
- Low EMI, requires less snubbing

### ABSOLUTE MAXIMUM RATINGS

PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS
Collector to emitter voltage	$V_{CES}$		1200	V
Continuous collector current	$I_C$	$T_C = 25\text{ °C}$	131	A
		$T_C = 80\text{ °C}$	89	
Pulsed collector current	$I_{CM}$		200	
Clamped inductive load current	$I_{LM}$		200	
Diode continuous forward current	$I_F$	$T_C = 25\text{ °C}$	59	
		$T_C = 80\text{ °C}$	39	
Gate to emitter voltage	$V_{GE}$		$\pm 20$	V
Power dissipation, IGBT	$P_D$	$T_C = 25\text{ °C}$	658	W
		$T_C = 80\text{ °C}$	369	
Power dissipation, diode	$P_D$	$T_C = 25\text{ °C}$	240	
		$T_C = 80\text{ °C}$	135	
Isolation voltage	$V_{ISOL}$	Any terminal to case, $t = 1$ min	2500	V

**ELECTRICAL SPECIFICATIONS** ( $T_J = 25\text{ }^{\circ}\text{C}$  unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Collector to emitter breakdown voltage	$V_{BR(CES)}$	$V_{GE} = 0\text{ V}$ , $I_C = 250\text{ }\mu\text{A}$	1200	-	-	V
Collector to emitter voltage	$V_{CE(on)}$	$V_{GE} = 15\text{ V}$ , $I_C = 75\text{ A}$	-	3.3	3.8	
		$V_{GE} = 15\text{ V}$ , $I_C = 75\text{ A}$ , $T_J = 125\text{ }^{\circ}\text{C}$	-	3.6	3.9	
Gate threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$ , $I_C = 250\text{ }\mu\text{A}$	4	5	6	
Temperature coefficient of threshold voltage	$V_{GE(th)}/\Delta T_J$	$V_{CE} = V_{GE}$ , $I_C = 1\text{ mA}$ ( $25\text{ }^{\circ}\text{C}$ to $125\text{ }^{\circ}\text{C}$ )	-	- 12	-	mV/ $^{\circ}\text{C}$
Collector to emitter leakage current	$I_{CES}$	$V_{GE} = 0\text{ V}$ , $V_{CE} = 1200\text{ V}$	-	3	250	$\mu\text{A}$
		$V_{GE} = 0\text{ V}$ , $V_{CE} = 1200\text{ V}$ , $T_J = 150\text{ }^{\circ}\text{C}$	-	4	20	mA
Forward voltage drop	$V_{FM}$	$I_C = 75\text{ A}$ , $V_{GE} = 0\text{ V}$	-	3.4	5.0	V
		$I_C = 75\text{ A}$ , $V_{GE} = 0\text{ V}$ , $T_J = 125\text{ }^{\circ}\text{C}$	-	3.3	5.2	
Gate to emitter leakage current	$I_{GES}$	$V_{GE} = \pm 20\text{ V}$	-	-	$\pm 200$	nA

**SWITCHING CHARACTERISTICS** ( $T_J = 25\text{ }^{\circ}\text{C}$  unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS	
Total gate charge (turn-on)	Q <sub>g</sub>	I <sub>C</sub> = 50 A, V <sub>CC</sub> = 600 V, V <sub>GE</sub> = 15 V		-	690	-	nC	
Gate to emitter charge (turn-on)	Q <sub>ge</sub>			-	65	-		
Gate to collector charge (turn-on)	Q <sub>gc</sub>			-	250	-		
Turn-on switching loss	E <sub>on</sub>	I <sub>C</sub> = 75 A, V <sub>CC</sub> = 600 V, V <sub>GE</sub> = 15 V, R <sub>g</sub> = 5 Ω, L = 500 μH, T <sub>J</sub> = 25 °C	Energy losses include tail and diode recovery (see fig. 18)	-	1.53	-	mJ	
Turn-off switching loss	E <sub>off</sub>			-	1.76	-		
Total switching loss	E <sub>tot</sub>			-	3.29	-		
Turn-on switching loss	E <sub>on</sub>	I <sub>C</sub> = 75 A, V <sub>CC</sub> = 600 V, V <sub>GE</sub> = 15 V, R <sub>g</sub> = 5 Ω, L = 500 μH, T <sub>J</sub> = 125 °C		-	2.49	-		
Turn-off switching loss	E <sub>off</sub>			-	3.45	-		
Total switching loss	E <sub>tot</sub>			-	5.94	-		
Turn-on delay time	t <sub>d(on)</sub>			-	281	-	ns	
Rise time	t <sub>r</sub>			-	45	-		
Turn-off delay time	t <sub>d(off)</sub>			-	300	-		
Fall time	t <sub>f</sub>			-	126	-		
Reverse bias safe operating area	RBSOA	T <sub>J</sub> = 150 °C, I <sub>C</sub> = 200 A, R <sub>g</sub> = 22 Ω, V <sub>GE</sub> = 15 V to 0 V, V <sub>CC</sub> = 900 V, V <sub>P</sub> = 1200 V, L = 500 μH		Fullsquare				
Diode reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = 50 A, dI <sub>F</sub> /dt = 200 A/μs, V <sub>R</sub> = 200 V		-	142	210	ns	
Diode peak reverse current	I <sub>rr</sub>			-	13	16	A	
Diode recovery charge	Q <sub>rr</sub>			-	923	1680	nC	
Diode reverse recovery time	t <sub>rr</sub>	I <sub>F</sub> = 50 A, dI <sub>F</sub> /dt = 200 A/μs, V <sub>R</sub> = 200 V, T <sub>J</sub> = 125 °C		-	202	260	ns	
Diode peak reverse current	I <sub>rr</sub>			-	18	22	A	
Diode recovery charge	Q <sub>rr</sub>			-	1818	2860	nC	

**THERMAL AND MECHANICAL SPECIFICATIONS**

PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS
Maximum junction and storage temperature range	$T_J, T_{Stg}$	- 40	-	150	°C
Junction to case	<div style="display: flex; align-items: center;"> <div style="flex: 1; border-bottom: 1px solid black; margin-bottom: 2px;"></div> <div style="text-align: center; margin: 0 5px;">IGBT</div> <div style="flex: 1; border-bottom: 1px solid black; margin-bottom: 2px;"></div> <div style="text-align: center; margin: 0 5px;">Diode</div> </div> $R_{thJC}$	-	-	0.19	°C/W
		-	-	0.52	
Case to sink per module	$R_{thCS}$	-	0.05	-	
Mounting torque, 6-32 or M3 screw		-	-	1.3	Nm
Weight		-	30	-	g

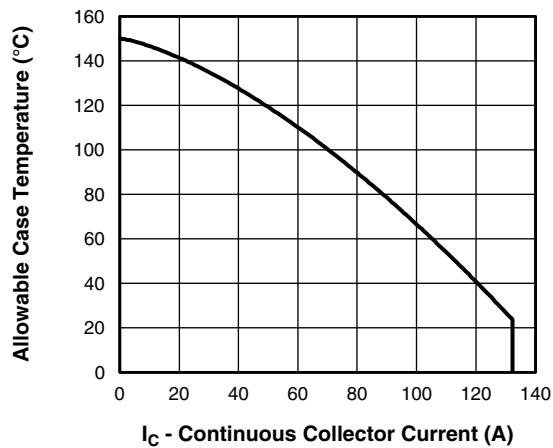


Fig. 1 - Maximum DC IGBT Collector Current vs. Case Temperature

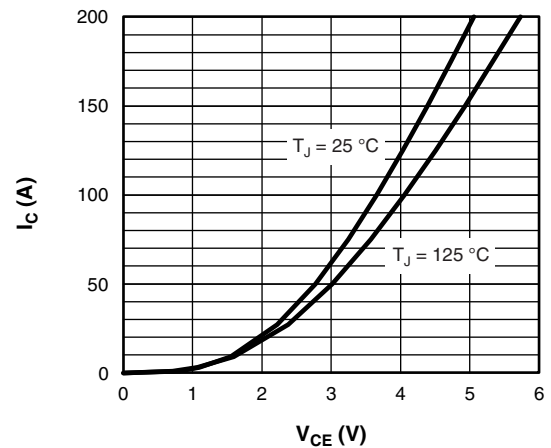


Fig. 3 - Typical IGBT Collector Current Characteristics

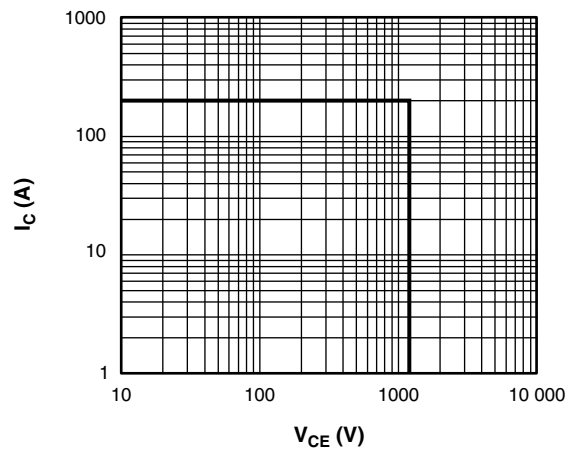
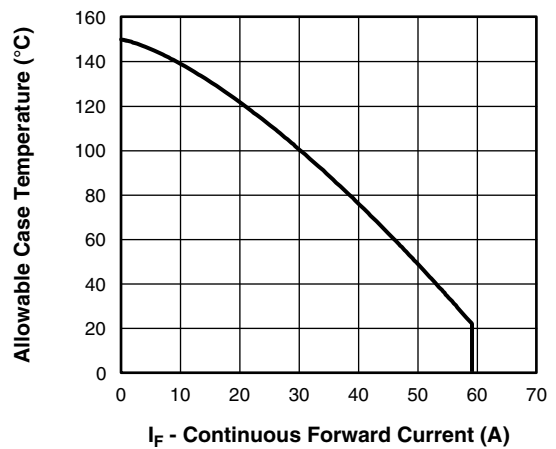

 Fig. 2 - IGBT Reverse Bias SOA  
 $T_J = 150\text{ °C}, V_{GE} = 15\text{ V}$ 


Fig. 4 - Maximum DC Forward Current vs. Case Temperature

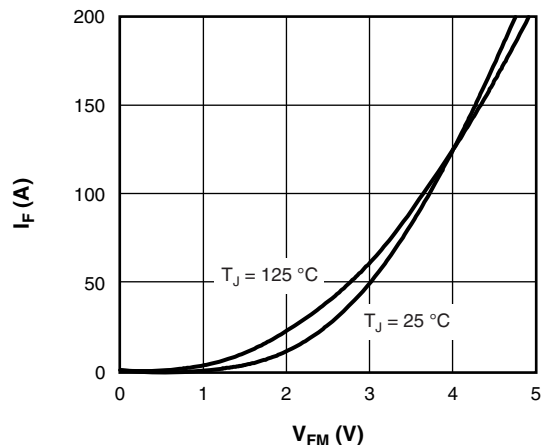


Fig. 5 - Typical Diode Forward Characteristics

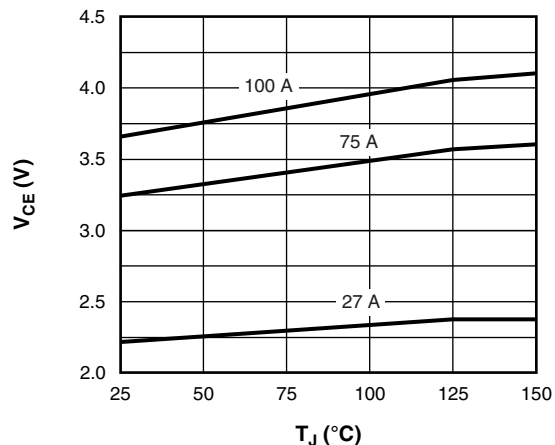


Fig. 8 - Typical IGBT Collector to Emitter Voltage vs. Junction Temperature,  $V_{GE} = 15$  V

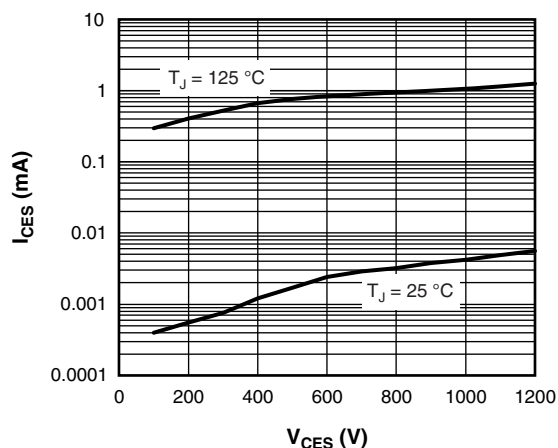


Fig. 6 - Typical IGBT Zero Gate Voltage Collector Current

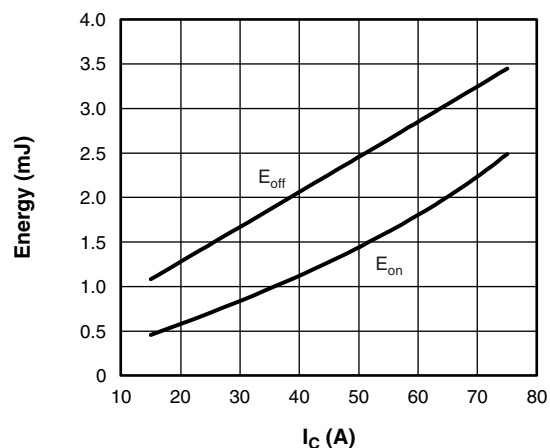


Fig. 9 - Typical IGBT Energy Loss vs.  $I_C$   
 $T_J = 125$  °C,  $L = 500$   $\mu$ H,  $V_{CC} = 600$  V,  
 $R_g = 5$   $\Omega$ ,  $V_{GE} = 15$  V

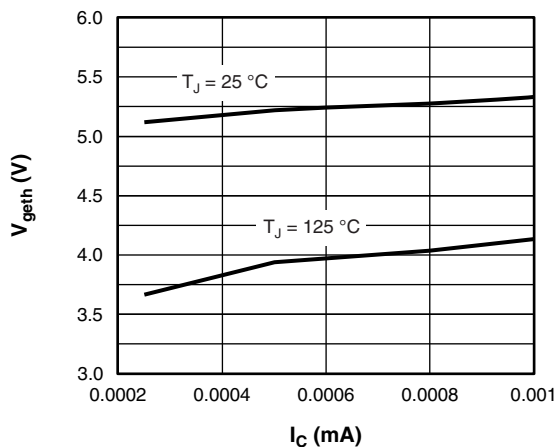


Fig. 7 - Typical IGBT Threshold Voltage

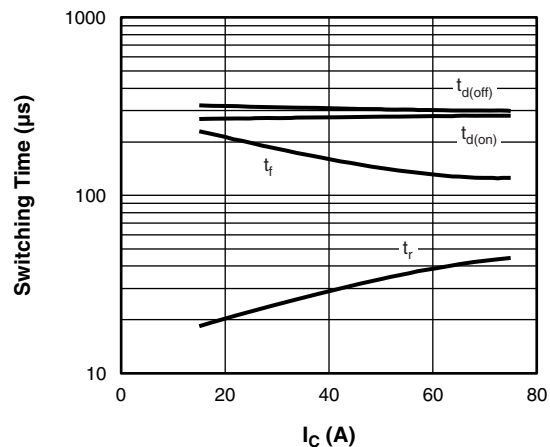


Fig. 10 - Typical IGBT Switching Time vs.  $I_C$   
 $T_J = 125$  °C,  $L = 500$   $\mu$ H,  $V_{CC} = 600$  V,  
 $R_g = 5$   $\Omega$ ,  $V_{GE} = 15$  V

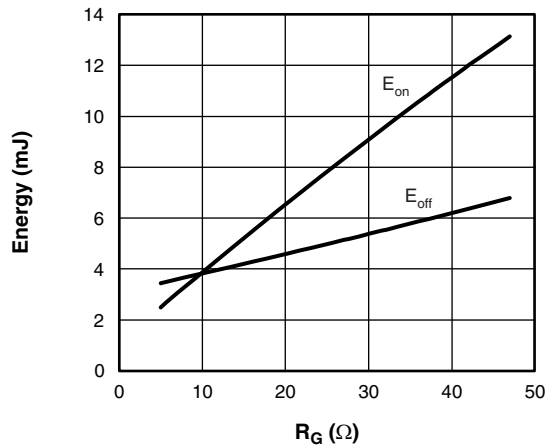


Fig. 11 - Typical IGBT Energy Loss vs.  $R_g$   
 $T_J = 125^\circ\text{C}$ ,  $I_C = 75\text{ A}$ ,  $L = 500\text{ }\mu\text{H}$ ,  
 $V_{CC} = 600\text{ V}$ ,  $V_{GE} = 15\text{ V}$

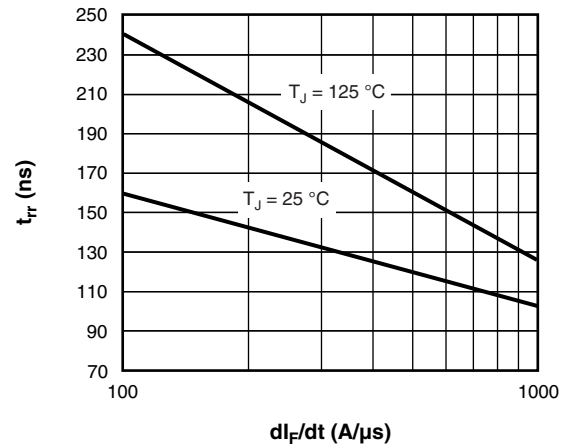


Fig. 13 - Typical  $t_{rr}$  diode vs.  $dI_F/dt$   
 $V_{RR} = 200\text{ V}$ ,  $I_F = 50\text{ A}$

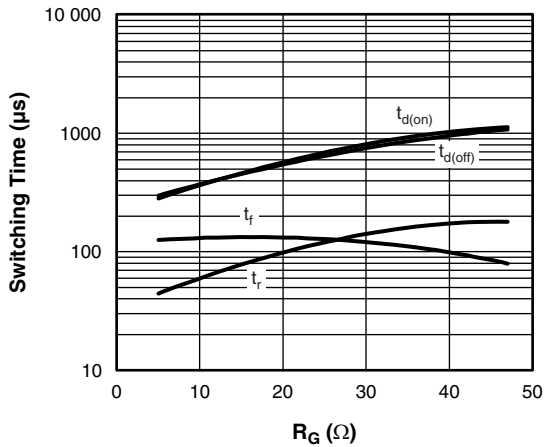


Fig. 12 - Typical IGBT Switching Time vs.  $R_g$   
 $T_J = 125^\circ\text{C}$ ,  $L = 500\text{ }\mu\text{H}$ ,  $V_{CC} = 600\text{ V}$ ,  
 $R_g = 5\text{ }\Omega$ ,  $V_{GE} = 15\text{ V}$

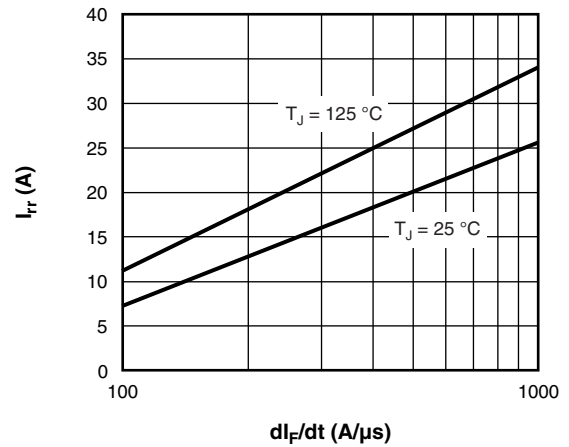


Fig. 14 - Typical  $I_{rr}$  diode vs.  $dI_F/dt$   
 $V_{RR} = 200\text{ V}$ ,  $I_F = 50\text{ A}$

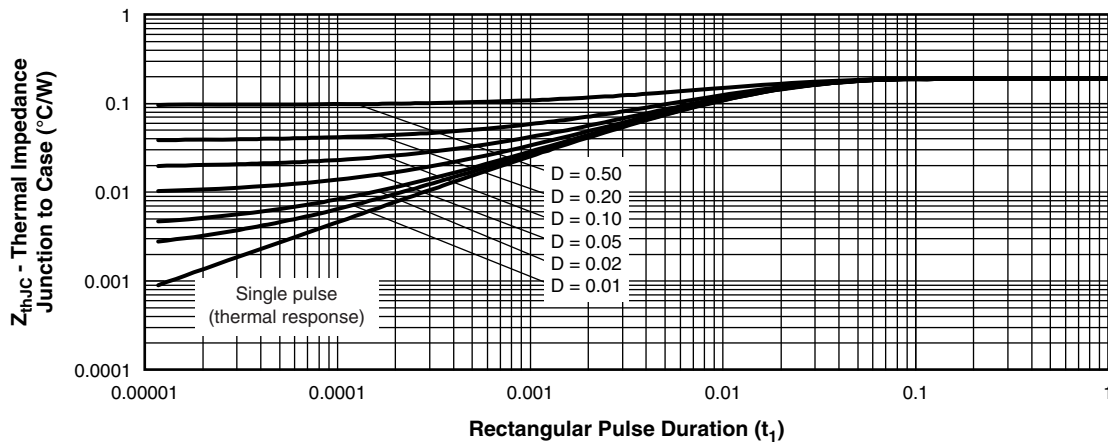


Fig. 15 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics (IGBT)

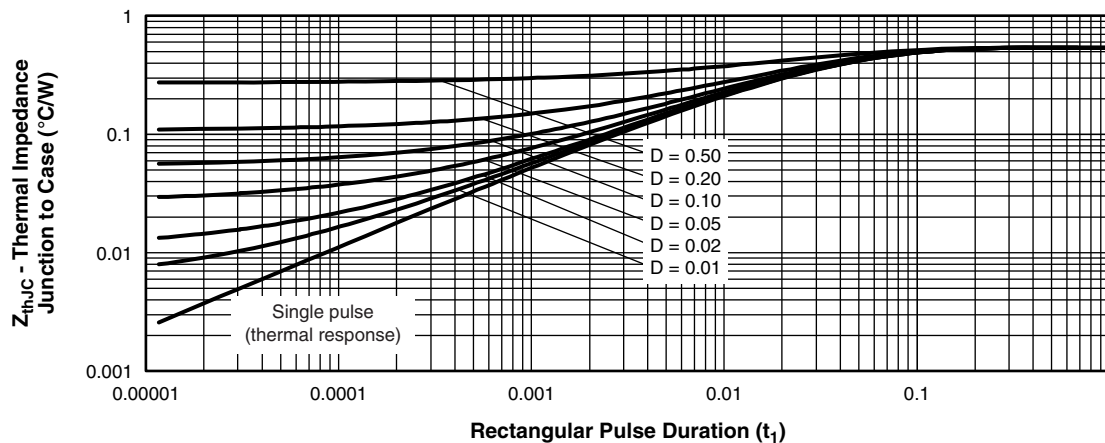


Fig. 16 - Maximum Thermal Impedance  $Z_{thJC}$  Characteristics (diode)

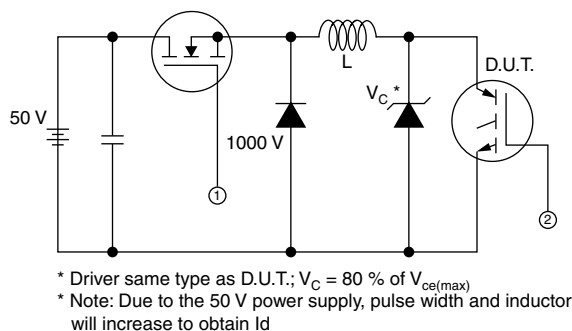


Fig. 17a - Clamped Inductive Load Test Circuit

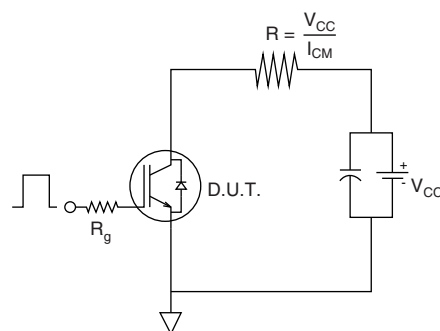


Fig. 17b - Pulsed Collector Current Test Circuit

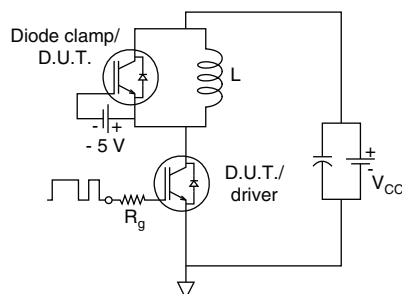


Fig. 18a - Switching Loss Test Circuit

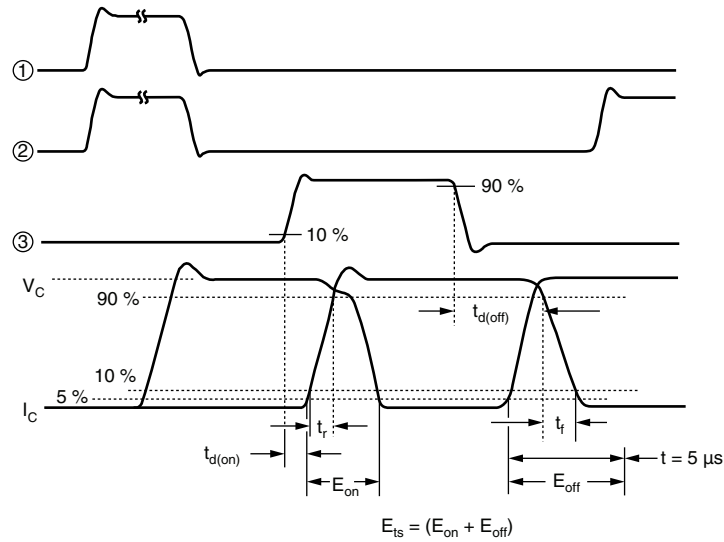


Fig. 18b - Switching Loss Waveforms Test Circuit

**ORDERING INFORMATION TABLE**

Device code	G	B	75	D	A	120	U	P
	1	2	3	4	5	6	7	8
	1	2	3	4	5	6	7	8
	- Insulated Gate Bipolar Transistor (IGBT)							
	- B = IGBT Generation 5							
	- Current rating (75 = 75 A)							
	- Circuit configuration (D = Single switch with antiparallel diode)							
	- Package indicator (A = SOT-227)							
	- Voltage rating (120 = 1200 V)							
	- Speed/type (U = Ultrafast IGBT)							
	- Totally lead (Pb)-free							

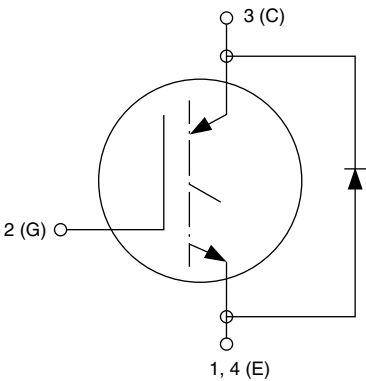
# GB75DA120UP

Vishay Semiconductors

Insulated Gate Bipolar Transistor  
(Ultrafast IGBT), 75 A



## CIRCUIT CONFIGURATION

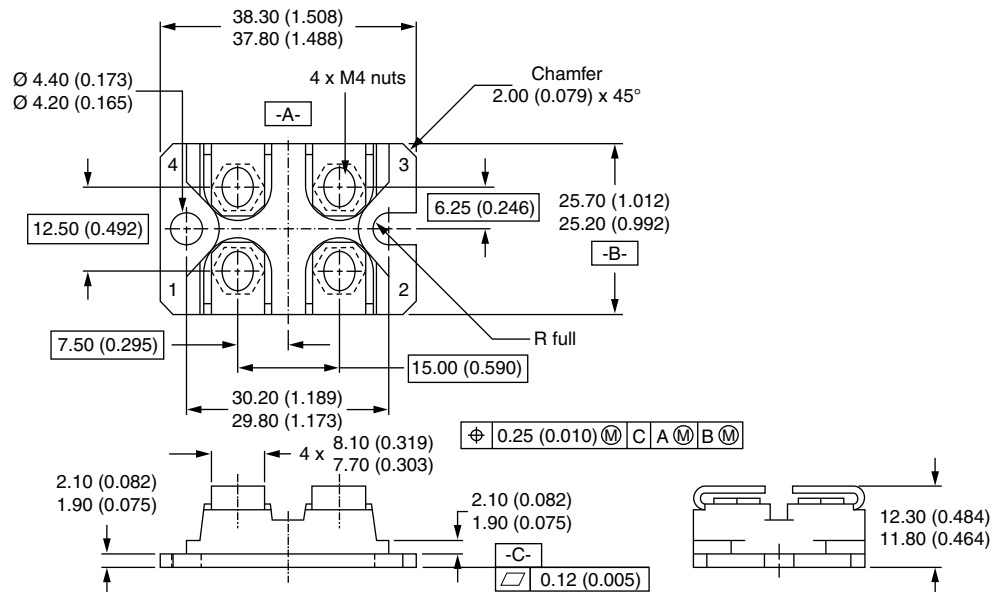


LINKS TO RELATED DOCUMENTS	
Dimensions	<a href="http://www.vishay.com/doc?95036">www.vishay.com/doc?95036</a>
Packaging information	<a href="http://www.vishay.com/doc?95037">www.vishay.com/doc?95037</a>



## SOT-227

**DIMENSIONS** in millimeters (inches)



### Notes

- Dimensioning and tolerancing per ANSI Y14.5M-1982
- Controlling dimension: millimeter



## Disclaimer

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